



承認書

SPECIFICATION FOR APPROVAL

CUSTOMER: _____

DESCRIPTION: WIRE WOUND CHIP INDUCTOR

PART NO: MWI0603FD系列

CUST. PART NO: _____

REV. NO. A0

DRAWING		
PREPARED	CHECKED	APPROVED
邹声平	卢嘉良	曾凡强
DATE:	2025/5/1	

CUSTOMER APPROVE



东莞市铭易轩电子科技有限公司

DongGuan Ming Yixuan Electronic Technology Co., LTD

地址: 广东省东莞市大朗镇景泰路20号VV大厦

电话: 15970768093 , 13640935893

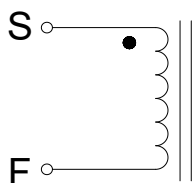
网址: <http://www.dgmingyixuan.com>

CUSTOMER:		REV. NO.	A0
PART NO:	MWI0603FD系列	PAGE NO:	2/6
CUST. PART NO:		DATE:	2025/5/1

1. SHAPE & DIMENSION (UNIT:mm)


Recommended patterns

L	W	T	E	F	D
1.85 Max.	1.15 Max.	0.8 Max.	0.64 Typ.	1.02 Typ.	0.64 Typ.

2. SCHEMATIC

3. PART NUMBERING SYSTEM

MWI	0603	FD	2R2	M	S	T	-	HF
1	2	3	4	5	6	7		8

- 1 PRODUCT SYMBOL (产品代号)
- 2 DIMENSIONS (规格尺寸)
- 3 MATERIAL (芯片类型)
- 4 INDUCTANCE (电感量)
- 5 TOLERANCE (公差) : J±5%; K±10%; M±20%
- 6 TERMINAL (端电极材料): S-锡端头
- 7 PACKAGING (包装方式): T-编带盘装; B-散装
- 8 E.P. (环保): LF—Lead Free HF—Halogen Free FP—Red Phosphor Free

APPROVED	CHECKED	PREPARED
曾凡强	卢嘉良	邹声平

CUSTOMER:		REV. NO.	A0
PART NO:	MWI0603FD系列	PAGE NO:	3/6
CUST. PART NO:		DATE:	2025/5/1

4. ELECTRICAL CHARACTERISTICS

No.	Part Number	L	L/Q Freq	Q	SRF	Rdc	Isat	Irms
		(uH)	(MHz)	(Min.)	(MHz) Typ.	(Ω)Max.	(mA) Typ.	(mA) Typ.
1	MWI0603FD1R0MST-HF	1	7.9	12	50	0.7	550	420
2	MWI0603FD2R2MST-HF	2.2	7.9	12	20	0.85	450	350
3	MWI0603FD4R7MST-HF	4.7	7.9	12	20	1.64	400	300
4	MWI0603FD100MST-HF	10	2.5	10	15	3.6	180	200

Test remarks

- (1). All tests were performed at room temperature $25 \pm 2^\circ\text{C}$.
- (2). Isat: DC current at which inductance drops approximate 30% from its value without current,
Irms: DC current that causes the temperature rise ($\Delta T \cong 40^\circ\text{C}$) from 25°C ambient.

5. GENERAL SPECIFICATION

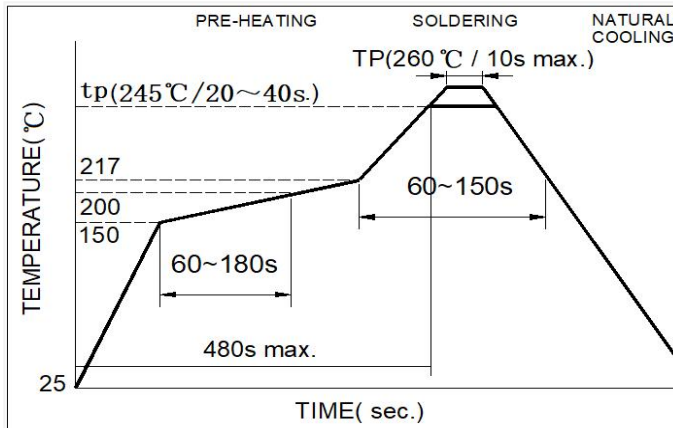
- (1). Operating temp.: $-40^\circ\text{C} \sim +85^\circ\text{C}$ (Including self-generated heat).
- (2). Storage temp.: $-10^\circ\text{C} \sim +40^\circ\text{C}$ R.H.: 65% Max.
- (3). Moisture sensitivity level (MSL) 1
- (4). Recommended products should be used within 12 months from the date of delivery
- (5). The part temperature (ambient + temp rise) should not exceed 85°C under worst case operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

APPROVED	CHECKED	PREPARED
曾凡强	卢嘉良	邹声平

CUSTOMER:		REV. NO.	A0
PART NO:	MWI0603FD系列	PAGE NO:	4/6
CUST. PART NO:		DATE:	2025/5/1

6. SOLDERING CONDITIONS

Figure 1. Re-flow Soldering (Lead Free)



Note:

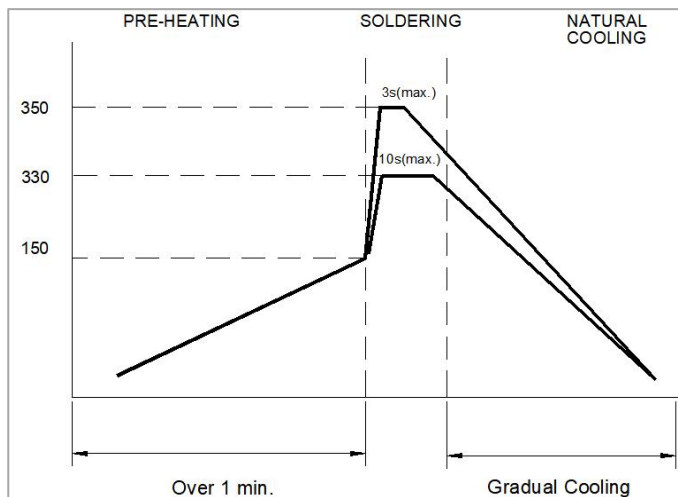
Preheat circuit and products to 150°C

260°C tip temperature (Max)

Reflow times: no more than 2 times

Solder paste thickness: the best 0.08mm is ,but max is 0.1mm

Figure 2. Hand Soldering



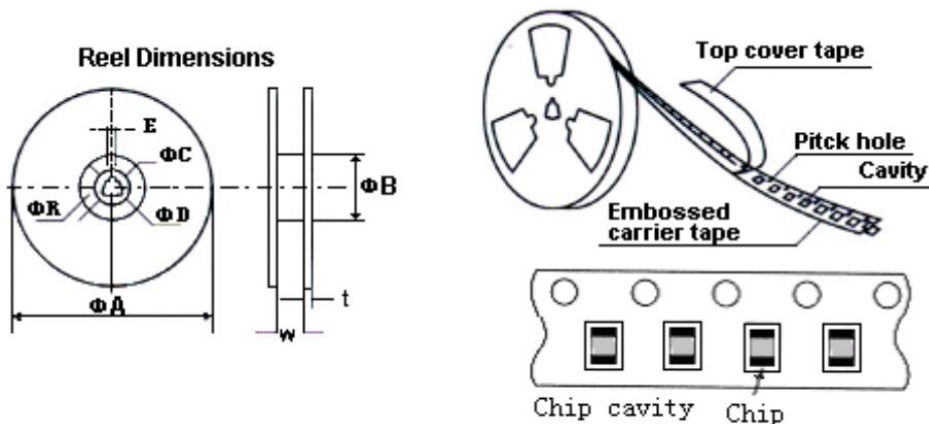
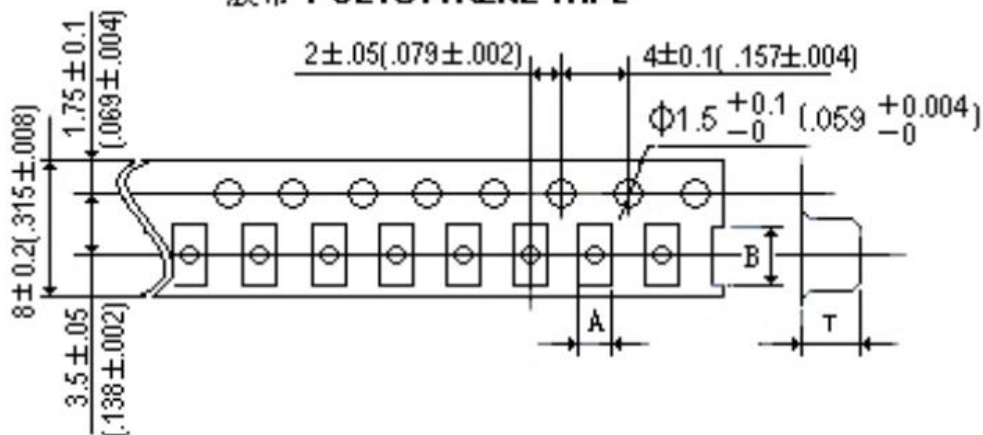
Note:

Use a 20 watt soldering iron with tip diameter of 1.0mm

Limit soldering time to 3 sec.

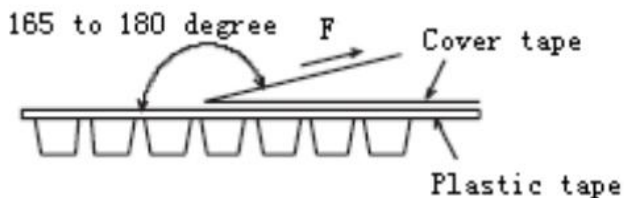
APPROVED	CHECKED	PREPARED
曾凡强	卢嘉良	邹声平

CUSTOMER:		REV NO:	A0
PART NO:	MWI0603FD系列	PAGE NO:	5/6
CUST. PART NO:		DATE:	2025/5/1

7. PACKAGE SPECIFICATION

胶带 POLYSTYRENE TAPE


Peeling off force

 Pull strength
 0402~1210:20g~80g

 Speed of peeling off:
 300mm/min \pm 10%


	A	B	T
胶带	1.15Typ.	1.83Typ.	0.95Typ.

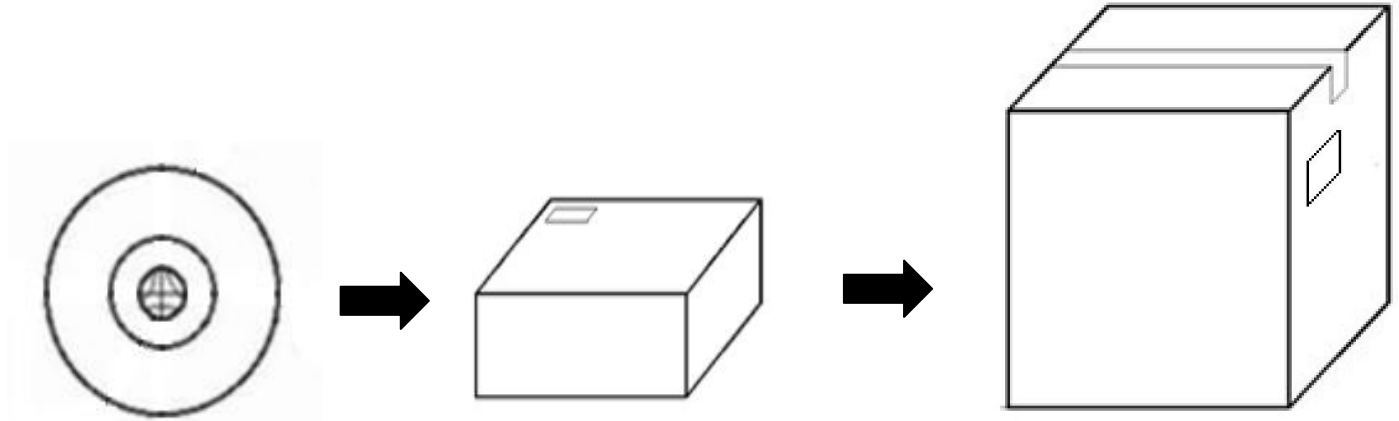
ΦA	ΦB	ΦC	ΦD	E	W	t	R
178Typ.	60Typ.	13Typ.	21Typ.	2Typ.	8.4Typ.	2Typ.	1Typ.

包装数量(PACKAGING QUANTITY): 4000Pcs/盘

注意: 此物料不涉及汽车或相关产品方面的应用, 否则, 由此引起的一切品质和责任问题, 我司将概不承担。

APPROVED	CHECKED	PREPARED
曾凡强	卢嘉良	邹声平

CUSTOMER:		REV NO:	A0
PART NO:	MWI0603FD系列	PAGE NO:	5/6
CUST. PART NO:		DATE:	2025/5/1

8.Package Specifications
Inside Box And Outside Carton


卷轴数量
每卷:4000PCS

内盒包装数量
每盒四盘, 共16000 PCS

外箱包装数量
小箱6盒, 共96000 PCS
中箱8盒, 共128000 PCS
大箱10盒, 共160000 PCS

内盒包装尺寸
20.3*19.3*5.5cm

外箱包装尺寸
小箱, 40.6*23*19.7cm
中箱, 41*22*26cm
大箱, 41*22*33cm

APPROVED	CHECKED	PREPARED
曾凡强	卢嘉良	邹声平